







TXU202-Q1 SCES949 - AUGUST 2022

# TXU0202-Q1 Single-Bit Fixed Direction Voltage-Level Translator With Schmitt-Trigger Inputs and 3-State Outputs

#### 1 Features

- Fully configurable dual-rail design allows each port to operate from 1.1 V to 5.5 V
- Up to 200 Mbps support for 3.3 V to 5.0 V
- Schmitt-trigger inputs allows for slow and noisy
- Inputs with integrated static pull-down resistors prevent channels from floating
- High drive strength (up to 12 mA at 5 V)
- Low power consumption
  - 2.5 µA maximum (25°C)
  - 6 μA maximum (–40°C to 125°C)
- $V_{CC}$  isolation and  $V_{CC}$  disconnect (I  $_{\text{off-float}}$  ) feature
  - If either V<sub>CC</sub> input is ;amplt;100 mV or disconnected, all outputs are disabled and become high-impedance
- I<sub>off</sub> supports partial-power-down mode operation
- Control logic (OE) with V<sub>CC(MIN)</sub> circuitry allows for control from either A or B port
- Pinout compatible with TXB family level shifters
- Available in another variant that supports common applications: TXU0102
- Operating temperature from -40°C to +125°C
- Latch-up performance exceeds 100 mA per JESD 78, class II
- ESD protection exceeds JESD 22
  - 2500-V human-body model
  - 1500-V charged-device model

## 2 Applications

- Eliminate slow or noisy input signals
- Driving indicator LEDs or buzzers
- Debouncing a mechanical switch
- General purpose I/O level shifting
- Push-pull level shifting (UART, SPI, JTAG, and so forth)

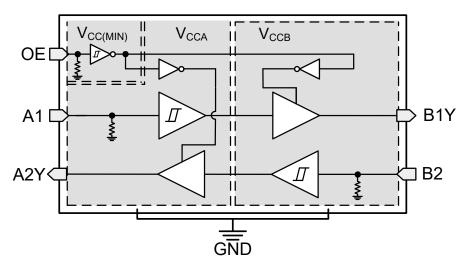
### 3 Description

TXU0202-Q1 is a 2-bit, dual-supply noninverting fixed direction voltage level translation device. The Ax pins are referenced to  $V_{\mbox{\scriptsize CCA}}$  logic level, the OE pin can be referenced to either  $V_{\text{CCA}}$  or  $V_{\text{CCB}}$  logic levels, and the Bx pins are referenced to  $V_{\text{CCB}}$  logic levels. The A port can accept input voltages ranging from 1.1 V to 5.5 V, while the B port can also accept input voltages from 1.1 V to 5.5 V. Fixed direction data transmission can occur from A to B or B to A when OE is set to high in reference to either supply. When OE is set to low, all output pins are in the high-impedance state. See Device Functional Modes for a summary of the operation of the control logic.

#### Package Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)				
TVI 10202	VSSOP (DCU) (8)	2.30 mm × 2.00 mm				
TXU0202	SON (DTT) (8)	1.95 mm × 1.00 mm				

For all available packages, see the orderable addendum at the end of the data sheet.



TXU0202-Q1 Functional Block Diagram



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## **4 Revision History**

DATE	REVISION	NOTES
August 2022	*	Initial Release



## 5 Pin Configuration and Functions—TXU0202-Q1

В2□	1 8	□B1Y B2	[]]	[8]	B1Y
GND□□	2 7	□V <sub>CCB</sub> GND	[2]	[7]	$V_{CCB}$
V <sub>CCA</sub> □□	3 6	□OE V <sub>CCA</sub>	[3]	[6]	OE
A2Y□□	4 5	□A1 A2Y	[4]	[5]	A1

Figure 5-1. DCU Package, 8-Pin VSSOP (Top View) Figure 5-2. DTT Package, 8-Pin SON Transparent (Top View)

Table 5-1. TXU0202 Pin Functions

·	TYPE <sup>(1)</sup>	DESCRIPTION					
NO.							
1	I	Input B2. Referenced to V <sub>CCB</sub> .					
2	_	Ground.					
3	_	A-port supply voltage. 1.1 V ≤ V <sub>CCA</sub> ≤ 5.5 V					
4	0	Output A2. Referenced to V <sub>CCA</sub> .					
5	ı	Input A1. Referenced to V <sub>CCA</sub> .					
6	1	Output Enable. Pull to GND to place all outputs in high-impedance mode. Pull to $V_{\text{CCA}}$ or $V_{\text{CCB}}$ to enable all outputs.					
7	_	B-port supply voltage. 1.1 V ≤ V <sub>CCB</sub> ≤ 5.5 V					
8	0	Output B1. Referenced to V <sub>CCB</sub> .					
	NO.  1 2 3 4 5 6 7	NO.  1					

<sup>(1)</sup> I = input, O = output



## **6 Specifications**

## **6.1 Absolute Maximum Ratings**

over operating free-air temperature range (unless otherwise noted)(1)

			MIN	MAX	UNIT
V <sub>CCA</sub>	Supply voltage A		-0.5	6.5	V
V <sub>CCB</sub>	Supply voltage B		-0.5	6.5	V
		I/O Ports (A Port)	-0.5	6.5	
VI	Input Voltage <sup>(2)</sup>	I/O Ports (B Port)	-0.5	6.5	V
		OE	-0.5	6.5	
.,	Voltage applied to any output in the high-impedance or power-off	A Port	-0.5	6.5	.,
Vo	state <sup>(2)</sup>	B Port	-0.5	6.5	V
.,	Value as a sufficient to a superior to the birth and accordance (2) (3)	A Port	-0.5	V <sub>CCA</sub> + 0.5	.,
Vo	Voltage applied to any output in the high or low state <sup>(2) (3)</sup>	B Port	-0.5 V <sub>CCB</sub> + 0.5		V
I <sub>IK</sub>	Input clamp current	V <sub>I</sub> < 0	-20		mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0	-20		mA
Io	Continuous output current	,	-25	25	mA
	Continuous current through V <sub>CC</sub> or GND	-100	100	mA	
Tj	Junction Temperature		150	°C	
T <sub>stg</sub>	Storage temperature		-65	150	°C

<sup>(1)</sup> Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

## 6.2 ESD Ratings

			VALUE	UNIT
V	(ESD) Electrostatic discharge	Human body model (HBM), per AEC Q100-002 (1)	±2500	V
(ESD)		Charged device model (CDM), per AEC Q100-011	±1500	<b>V</b>

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

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<sup>(2)</sup> The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(3)</sup> The output positive-voltage rating may be exceeded up to 6.5 V maximum if the output current rating is observed.



## **6.3 Recommended Operating Conditions**

over operating free-air temperature range (unless otherwise noted) (1) (2) (3)

				MIN	MAX	UNIT			
V <sub>CCA</sub>	Supply voltage A			1.08	5.5	V			
V <sub>CCB</sub>	Supply voltage B			1.08	5.5	V			
			V <sub>CCO</sub> = 1.1 V		-1.5				
			V <sub>CCO</sub> = 1.4 V		-3				
1	High-level output current		V <sub>CCO</sub> = 1.65 V		-4.5	mA			
Іон			V <sub>CCO</sub> = 2.3 V		-8	IIIA			
			V <sub>CCO</sub> = 3 V		-10				
			V <sub>CCO</sub> = 4.5 V		-12				
			V <sub>CCO</sub> = 1.1 V		1.5				
			V <sub>CCO</sub> = 1.4 V		3				
	Low lovel output or	urrant	V <sub>CCO</sub> = 1.65 V		4.5	A			
I <sub>OL</sub>	Low-level output co	urrent	V <sub>CCO</sub> = 2.3 V		8	mA			
			V <sub>CCO</sub> = 3 V		10				
			V <sub>CCO</sub> = 4.5 V		12				
VI	Input voltage (3)		·	0	5.5	V			
\/	Output valtage	Active State				V			
Vo	Output voltage	Tri-State		0	5.5	V			
T <sub>A</sub>	Operating free-air	temperature		-40	125	°C			

 $V_{\text{CCI}}$  is the  $V_{\text{CC}}$  associated with the input port.

#### **6.4 Thermal Information**

		TXU02	TXU0202-Q1					
	THERMAL METRIC (1)	DCU (VSSOP)	DTT (SON)	UNIT				
		8 PINS	8 PINS					
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	257.0	249.8	°C/W				
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	106.9	175.2	°C/W				
$R_{\theta JB}$	Junction-to-board thermal resistance	168.3	145.4	°C/W				
Y <sub>JT</sub>	Junction-to-top characterization parameter	47.2	32.1	°C/W				
$Y_{JB}$	Junction-to-board characterization parameter	167.3	145.0	°C/W				

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

<sup>(2)</sup> V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.

All control inputs and data I/Os of this device have weak pulldowns to ensure the line is not floating when undefined external to the device. The input leakage from these weak pulldowns is defined by the I<sub>I</sub> specification indicated under *Electrical Characteristics*.



## **6.5 Electrical Characteristics**

over operating free-air temperature range (unless otherwise noted)(1) (2)

					Operating free-air temperature (T <sub>A</sub> )				A)			
PARAMETER 1		TEST CONDITIONS	V <sub>CCA</sub>	V <sub>CCB</sub>		25°C		–40°	C to 85°C	–40°	C to 125°C	UNI
					MIN	TYP	MAX	MIN	TYP MAX	MIN	TYP MAX	
			1.1 V	1.1 V				0.44	0.88	0.44	0.88	
			1.4 V	1.4 V				0.60	0.98	0.60	0.98	
		Data Inputs	1.65 V	1.65 V				0.76	1.13	0.76	1.13	
		(Ax, Bx)	2.3 V	2.3 V				1.08	1.56	1.08	1.56	V
		(Referenced to V <sub>CCI</sub> )	3 V	3 V				1.48	1.92	1.48	1.92	
	Positive-		4.5 V	4.5 V				2.19	2.74	2.19	2.74	
,	going input-		5.5 V	5.5 V				2.65	3.33	2.65	3.33	
/ <sub>T+</sub>	threshold		1.1 V	1.1 V				0.44	0.88	0.44	0.88	
	voltage		1.4 V	1.4 V				0.60	0.98	0.60	0.98	
		OE	1.65 V	1.65 V				0.76	1.13	0.76	1.13	
		(Referenced to V <sub>CCA</sub>	2.3 V	2.3 V				1.08	1.56	1.08	1.56	V
		or V <sub>CCB)</sub>	3 V	3 V				1.48	1.92	1.48	1.92	
			4.5 V	4.5 V				2.19	2.74	2.19	2.74	
			5.5 V	5.5 V				2.65	3.33	2.65	3.33	
			1.1 V	1.1 V				0.17	0.48	0.17	0.48	
		Data Inputs (Ax, Bx)	1.4 V	1.4 V				0.28	0.59	0.28	0.59	
			1.65 V	1.65 V				0.35	0.69	0.35	0.69	
			2.3 V	2.3 V				0.56	0.97	0.56	0.97	V
		(Referenced to V <sub>CCI</sub> )	3 V	3 V				0.89	1.5	0.89	1.5	
			4.5 V	4.5 V				1.51	1.97	1.51	1.97	
	Negative- going input- threshold		5.5 V	5.5 V				1.88	2.4	1.88	2.4	1
/ <sub>T-</sub>			1.1 V	1.1 V				0.17	0.48	0.17	0.48	
	voltage	OE (Referenced to V <sub>CCA</sub> or V <sub>CCB)</sub>	1.4 V	1.4 V				0.28	0.59	0.28	0.59	1
			1.65 V	1.65 V				0.35	0.69	0.35	0.69	-
			2.3 V	2.3 V				0.56	0.97	0.56	0.97	V
			3 V	3 V				0.89	1.5	0.89	1.5	
			4.5 V	4.5 V				1.51	1.97	1.51	1.97	
			5.5 V	5.5 V				1.88	2.46	1.88	2.46	
			1.1 V	1.1 V				0.2	0.4	0.2	0.4	
			1.4 V	1.4 V				0.25	0.5	0.25	0.5	-
		5	1.65 V	1.65 V				0.3	0.55	0.3	0.55	-
		Data Inputs (Ax, Bx)	2.3 V	2.3 V				0.38	0.65	0.38	0.65	-
		(Referenced to V <sub>CCI</sub> )	3 V	3 V				0.46	0.72	0.46	0.72	-
			4.5 V	4.5 V				0.58	0.93	0.58	0.93	-
	Input-		5.5 V	5.5 V				0.69	1.06	0.69	1.06	-
ΔVT	threshold hysteresis		1.1 V	1.1 V				0.15	0.41	0.15	0.41	-
	$(V_{T+} - V_{T-})$		1.4 V	1.4 V				0.2	0.5	0.10	0.5	-
			1.65 V	1.4 V				0.23	0.55	0.23	0.55	-
		OE (Referenced to V <sub>CCA</sub>	2.3 V	2.3 V				0.23	0.65	0.23	0.65	
		or V <sub>CCB)</sub>	3 V	3 V				0.32	0.03	0.32	0.03	-
												-
	I	4 5	4.5 V	4.5 V				0.57	0.97	0.57	0.97	

## **6.5 Electrical Characteristics (continued)**

over operating free-air temperature range (unless otherwise noted)(1) (2)

						O	peratir	ng free	air tei	mpera	ture (T	۵)		
PA	RAMETER	TEST CONDITIONS	V <sub>CCA</sub>	V <sub>CCB</sub>		25°C		–40°	C to 8	5°C	-40°0	C to 12	25°C	UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
		$I_{OH} = -0.1 \text{ mA}$	1.1 V – 5.5 V	1.1 V – 5.5 V				V <sub>CCO</sub> - 0.1			V <sub>CCO</sub> - 0.1			
		$I_{OH} = -0.5 \text{ mA}$	1.1 V	1.1 V				0.82			0.82			
	High-level	$I_{OH} = -3 \text{ mA}$	1.4 V	1.4 V				1			1			.,
V <sub>OH</sub>	output voltage <sup>(3)</sup>	I <sub>OH</sub> = -4.5 mA	1.65 V	1.65 V				1.2			1.2			V
		I <sub>OH</sub> = -8 mA	2.3 V	2.3 V				1.7			1.7			
		I <sub>OH</sub> = -10 mA	3 V	3 V				2.2			2.2			
	·	I <sub>OH</sub> = -12 mA	4.5 V	4.5 V				3.7			3.7			
		I <sub>OL</sub> = 0.1 mA	1.1 V – 5.5 V	1.1 V – 5.5 V						0.1			0.1	
		I <sub>OL</sub> = 0.5 mA	1.1 V	1.1 V						0.27			0.27	
		I <sub>OL</sub> = 3 mA	1.4 V	1.4 V						0.35			0.35	
.,	Low-level	I <sub>OL</sub> = 4.5 mA	1.65 V	1.65 V						0.45			0.45	V
V <sub>OL</sub>	output voltage <sup>(4)</sup>	I <sub>OL</sub> = 8 mA	2.3 V	2.3 V						0.7			0.7	V
		I <sub>OL</sub> = 10 mA	3 V	3 V						0.8			0.8	
		I <sub>OL</sub> = 8 mA	4.5 V	4.5 V						0.55			0.55	
		I <sub>OL</sub> = 12 mA	4.5 V	4.5 V						0.8			0.8	
I. I	Input leakage current	OE V <sub>I</sub> = V <sub>CC</sub> or GND	1.1 V – 5.5 V	1.1 V – 5.5 V	-0.1		1.5	-0.1		1.5	-0.1		2	μA
		Data Inputs (Ax, Bx) V <sub>I</sub> = V <sub>CCI</sub> or GND	1.1 V – 5.5 V	1.1 V – 5.5 V	-0.1		1.5	-0.1		1.5	-2		2	μΑ
	Partial power	A Port or B Port	0 V	1.1 V – 5.5 V	-1.5		1.5	-2		2	-2.5		2.5	
off	down current	$V_{I}$ or $V_{O} = 0 V - 5.5 V$	1.1 V – 5.5 V	0 V	-1.5		1.5	-2		2	-2.5		2.5	μA
	Floating		Floating <sup>(5)</sup>	1.1 V – 5.5 V	-1.5		1.5	-2		2	-2.5		2.5	
off- loat	supply Partial power down current	A Port or B Port $V_I$ or $V_O = GND$	0 V – 5.5 V	Floating <sup>(5)</sup>	-1.5		1.5	-2		2	-2.5		2.5	μΑ
oz	Tri-state output current	A or B Port: $V_1 = V_{CCI}$ or GND $V_0 = V_{CCO}$ or GND OE = GND	1.1 V – 5.5 V	1.1 V – 5.5 V	-0.3		0.3	-1		1	-2		2	μA
		V V	1.1 V – 5.5 V	1.1 V – 5.5 V			1.5			2.5			6	
	V <sub>CCA</sub> supply	$V_I = V_{CCI}$ or GND $I_O = 0$	0 V	5.5 V	-0.3			-1			-1			
CCA	current		5.5 V	0 V			1			1.5			3	μΑ
		$V_I = GND$ $I_O = 0$	5.5 V	Floating <sup>(5)</sup>			1.5			7			15	
		., .,	1.1 V – 5.5 V	1.1 V – 5.5 V			1.5			2.5			6	
	V supply	$V_I = V_{CCI}$ or GND $I_O = 0$	0 V	5.5 V			1			1.5			3	
ССВ	V <sub>CCB</sub> supply current	10 0	5.5 V	0 V	-0.3			-1			-1			μΑ
		V <sub>I</sub> = GND I <sub>O</sub> = 0	Floating <sup>(5)</sup>	5.5 V			1.5			7			15	
CCA - CCB	Combined supply current	V <sub>I</sub> = V <sub>CCI</sub> or GND I <sub>O</sub> = 0	1.1 V – 5.5 V	1.1 V – 5.5 V			2.5			3			6	μΑ
C <sub>i</sub>	Control Input Capacitance	V <sub>I</sub> = 3.3 V or GND	3.3 V	3.3 V		2.75			3			3.5		рF



## **6.5 Electrical Characteristics (continued)**

over operating free-air temperature range (unless otherwise noted)(1) (2)

					Operating free-air temperature (T <sub>A</sub> )										
PA	RAMETER	TEST CONDITIONS	V <sub>CCA</sub>	V <sub>CCB</sub>	25°C		-40°C to 85°C			-40°C to 125°C			UNIT		
					MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
C <sub>io</sub>	Data I/O Capacitance	OE = GND, $V_0$ = 1.65 V DC +1 MHz -16 dBm sine wave	3.3 V	3.3 V	3		3		3		4		4 4		pF

- V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.
   V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.
   Tested at V<sub>I</sub> = V<sub>T+(MAX)</sub>.
   Tested at V<sub>I</sub> = V<sub>T-(MIN)</sub>.
   Floating is defined as a node that is both not actively driven by an external device and has leakage not exceeding 10 nA.

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## 6.6 Switching Characteristics, $V_{CCA} = 1.2 \pm 0.1 \text{ V}$

See Figure 7-1 and Table 7-1 for test circuit and loading. See Figure 7-2, Figure 7-3, and Figure 7-4 for measurement waveforms.

										В	-Port S	upply	Voltag	e (V <sub>CCI</sub>	3)							
	PARAMETER	FROM	то	Test Conditions	1.2 ±	: 0.1 V	1.	5 ± 0.1	٧	1.8	± 0.15	V	2.	5 ± 0.2	٧	3.	3 ± 0.3	٧	5.	0 ± 0.5	٧	UNIT
					MIN T	YP MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
		^	В	-40°C to 85°C	3.3	96	0.5		43	0.5		37	0.5		32	0.5		30	0.5		31	
	Propagation	Α	В	-40°C to 125°C	3.3	96	0.5		43	0.5		37	0.5		32	0.5		30	0.5		31	ns
t <sub>pd</sub>	delay	В	Α	-40°C to 85°C	3.3	95	1.9		80	0.5		75	0.5		70	0.5		69	0.5		69	115
		В		-40°C to 125°C	3.3	95	1.9		80	0.5		75	0.5		70	0.5		69	0.5		69	
		OE	Α	-40°C to 85°C	28.8	133	28.5		130	28.4		133	28.8	-	137	28.4		143	18.7		211	
<b>.</b>	Disable time	OL		-40°C to 125°C	28.8	133	28.5		130	28.4		133	28.8		137	28.4		143	18.7		211	ns
t <sub>dis</sub>	Disable time	OE	В	-40°C to 85°C	32.5	150	27.6		117	25.8		110	22.5		104	22.1		112	20.1		181	115
		OL		-40°C to 125°C	32.5	150	27.6		117	25.8		110	22.5		104	22.1		112	20.1		181	
		OE	Α	-40°C to 85°C	24.1	237	22.1		229	21.4		230	21.3		232	21.7		235	22.7		244	
	Enable time	OL		-40°C to 125°C	24.1	237	22.1		229	21.4		230	21.3		232	21.7		235	22.7		244	ne
t <sub>en</sub>	Lilable tille	OE	В	-40°C to 85°C	21.3	237	14.3		152	11.2		140	8.8		130	8.2		130	8.4		132	ns
		OL		-40°C to 125°C	21.3	237	14.3		152	11.2		140	8.8		130	8.2		130	8.4		132	

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## 6.7 Switching Characteristics, $V_{CCA} = 1.5 \pm 0.1 \text{ V}$

See Figure 7-1 and Table 7-1 for test circuit and loading. See Figure 7-2, Figure 7-3, and Figure 7-4 for measurement waveforms.

				_ ,						В	-Port S	Supply	Voltag	e (V <sub>CC</sub>	в)							
	PARAMETER	FROM	то	Test Conditions	1.2	± 0.1 V	1.	5 ± 0.1	٧	1.8	3 ± 0.15	5 V	2.	5 ± 0.2	: <b>V</b>	3.	3 ± 0.3	٧	5.	0 ± 0.5	٧	UNIT
					MIN 7	TYP MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
		Α	В	-40°C to 85°C	1.9	80	0.5		31	0.5		25	0.5		19	0.5		17	0.5		15	
<b>.</b>	Propagation			-40°C to 125°C	1.9	80	0.5		31	0.5		25	0.5		20	0.5		18	0.5		16	ns
t <sub>pd</sub>	delay	В	Α	-40°C to 85°C	0.5	43	0.5		31	0.5		28	0.5		26	0.5		25	0.5		24	115
				-40°C to 125°C	0.5	43	0.5		31	0.5		28	0.5		26	0.5		25	0.5		24	
		OE	A	-40°C to 85°C	20.0	91	19.0		82	18.8		81	19.2		82	19.6		83	12.2		90	
<b>.</b>	Disable time	OL	^	-40°C to 125°C	20.0	95	19.0		86	18.8		85	19.2		87	19.6		88	12.2		92	ns
t <sub>dis</sub>	Disable time	OE	В	-40°C to 85°C	27.4	127	21.7		91	19.9		82	16.3		71	15.9		71	13.7		70	115
		OL		-40°C to 125°C	27.4	127	21.7		95	19.9		86	16.3		75	15.9		75	13.7		74	
		OE	Α	-40°C to 85°C	14.9	102	14.4		86	13.5		88	12.7		90	12.6		92	13.2		97	
	Enable time	OE	^	-40°C to 125°C	14.9	102	14.4		89	13.5		91	12.7		93	12.6		96	13.2		100	no
t <sub>en</sub>	Lilable tille	OE	В	-40°C to 85°C	17.9	175	12.7		80	9.1		69	6.1		57	4.9		53	4.5		54	ns
		OL	D	-40°C to 125°C	17.9	175	12.7		81	9.1		71	6.1		60	4.9		56	4.5		57	



## 6.8 Switching Characteristics, $V_{CCA} = 1.8 \pm 0.15 \text{ V}$

See Figure 7-1 and Table 7-1 for test circuit and loading. See Figure 7-2, Figure 7-3, and Figure 7-4 for measurement waveforms.

									B-Po	rt Supply	Voltage (V	ссв)					
	PARAMETER	FROM	то	Test Conditions	1.2 ± 0.	1 V	1.5 ± 0	.1 V	1.8 ±	0.15 V	2.5 ± (	).2 V	3.3 ± 0	.3 V	5.0 ± 0	).5 V	UNIT
					MIN TYP	MAX	MIN TYP	MAX	MIN TY	P MAX	MIN TY	MAX	MIN TYP	MAX	MIN TY	P MAX	
		Α	В	-40°C to 85°C	0.5	75	0.5	28	0.5	22	0.5	17	0.5	14	0.5	12	
	Propagation			-40°C to 125°C	0.5	75	0.5	28	0.5	23	0.5	17	0.5	15	0.5	13	ns
t <sub>pd</sub>	delay	В	Α	-40°C to 85°C	0.5	37	0.5	25	0.5	22	0.5	19	0.5	19	0.5	18	1115
		В		-40°C to 125°C	0.5	37	0.5	25	0.5	23	0.5	20	0.5	19	0.5	19	
		OE	Α	-40°C to 85°C	17.2	79	14.7	67	14.5	65	14.3	65	14.4	66	8.5	71	
	Disable time	OL		-40°C to 125°C	17.2	83	14.7	71	14.5	69	14.3	70	14.4	71	8.5	75	ns
t <sub>dis</sub>	Disable time	OE	В	-40°C to 85°C	25.4	121	18.7	81	16.5	71	12.8	60	12.5	58	9.8	55	115
		OL		-40°C to 125°C	25.4	123	18.7	86	16.5	76	12.8	64	12.5	62	9.8	59	
		OE	Α	-40°C to 85°C	10.9	88	9.5	66	9.4	63	8.6	65	8.2	66	8.1	69	
	Enable time	OL		-40°C to 125°C	10.9	88	9.5	69	9.4	67	8.6	68	8.2	70	8.1	73	
t <sub>en</sub>	Lilable tille	OE	В	-40°C to 85°C	16.7	177	10.4	75	8.1	58	4.9	46	3.3	42	2.2	39	ns
		OL		-40°C to 125°C	16.7	177	10.4	77	8.1	60	4.9	49	3.3	44	2.2	42	

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## 6.9 Switching Characteristics, $V_{CCA} = 2.5 \pm 0.2 \text{ V}$

See Figure 7-1 and Table 7-1 for test circuit and loading. See Figure 7-2, Figure 7-3, and Figure 7-4 for measurement waveforms.

											В	-Port S	Supply	Voltag	e (V <sub>CC</sub>	в)							
	PARAMETER	FROM	то	Test Conditions	1.	2 ± 0.1 \	V	1.	5 ± 0.1	٧	1.8	3 ± 0.15	5 V	2.	5 ± 0.2	٧	3.	3 ± 0.3	٧	5.	0 ± 0.5	٧	UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
		Α	В	-40°C to 85°C	0.5		70	0.5		26	0.5		20	0.5		14	0.5		12	0.5		9	
	Propagation			-40°C to 125°C	0.5		70	0.5		26	0.5		20	0.5		14	0.5		12	0.5		10	ns
t <sub>pd</sub>	delay	В	Α	-40°C to 85°C	0.5		32	0.5		19	0.5		17	0.5		14	0.5		13	0.5		13	115
		B		-40°C to 125°C	0.5		32	0.5		20	0.5		17	0.5		14	0.5		13	0.5		13	
		OE	Α	-40°C to 85°C	12.9		65	10.5		51	9.0		51	8.1		43	8.4		44	5.0		45	
t <sub>dis</sub>	Disable time	OL		-40°C to 125°C	12.9		68	10.5		55	9.0		50	8.1		47	8.4		48	5.0		49	ns
<sup>L</sup> dis	Disable time	OE	В	-40°C to 85°C	23.2		112	16.5		74	14.0		61	9.0		46	9.1		44	6.4		39	115
		OL		-40°C to 125°C	23.2		115	16.5		79	14.0		66	9.0		51	9.1		48	6.4		43	
		OE	Α	-40°C to 85°C	7.9		80	5.9		50	5.1		44	4.7		39	4.4		40	3.7		41	
	Enable time	OE	^	-40°C to 125°C	7.9		80	5.9		53	5.1		47	4.7		42	4.4		43	3.7		44	, no
t <sub>en</sub>	Liable tille	OE	В	-40°C to 85°C	16.3		183	9.2		74	6.0		54	4.0		36	2.1		31	0.5		27	ns
		OL		-40°C to 125°C	16.3		183	9.2		76	6.0		57	4.0		38	2.1		33	0.5		29	

Product Folder Links: TXU202-Q1



## 6.10 Switching Characteristics, $V_{CCA} = 3.3 \pm 0.3 V$

See Figure 7-1 and Table 7-1 for test circuit and loading. See Figure 7-2, Figure 7-3, and Figure 7-4 for measurement waveforms.

				_ ,						B-Port	Supply	Voltag	e (V <sub>CC</sub>	в)							
	PARAMETER	FROM	то	Test Conditions	1.2 ± 0.1	V	1.9	5 ± 0.1 V	1	.8 ± 0.1	5 V	2.	5 ± 0.2	٧	3.	3 ± 0.3	٧	5.0	) ± 0.5	٧	UNIT
					MIN TYP	MAX	MIN	TYP MA	X MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
		Α	В	-40°C to 85°C	0.5	69	0.5	2	5 0.5	j	19	0.5		13	0.5		11	0.5		8	
	Propagation			-40°C to 125°C	0.5	69	0.5	2	5 0.5	j	19	0.5		13	0.5		11	0.5		9	ns
t <sub>pd</sub>	delay	В	Α	-40°C to 85°C	0.5	30	0.5	1	7 0.5	j	14	0.5		12	0.5		11	0.5		10	115
		В	^	-40°C to 125°C	0.5	30	0.5	1	8 0.5	j	15	0.5		12	0.5		11	0.5		10	
		OE	Α	-40°C to 85°C	12.9	62	10.1	4	7 8.7	,	42	6.9		39	6.6		39	6.9		40	
	Disable times	OE	^	-40°C to 125°C	12.9	65	10.1	5	1 8.7	•	46	6.9		40	6.6		40	6.9		40	
t <sub>dis</sub>	Disable time	OE	В	-40°C to 85°C	22.7	109	15.7	7	1 13.2	2	59	8.5		42	7.6		40	4.7		36	ns
				-40°C to 125°C	22.7	111	15.7	7	5 13.2	2	63	8.5		46	7.6		43	4.7		36	
		OE	Α	-40°C to 85°C	6.6	85	4.2	4	5 3.0	)	37	2.4		31	2.2		30	1.7		30	
	Enable time	OE	^	-40°C to 125°C	6.6	85	4.2	4	7 3.0	)	40	2.4		33	2.2		32	1.7		33	
t <sub>en</sub>	Lilable tille	OE	В	-40°C to 85°C	16.3	192	8.9	7	6 5.4	ļ	55	2.6		34	1.8		27	0.5		22	ns
		OL		-40°C to 125°C	16.3	192	8.9	7	8 5.4	,	57	2.6	•	36	1.8		29	0.5		24	

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## 6.11 Switching Characteristics, $V_{CCA} = 5.0 \pm 0.5 \text{ V}$

See Figure 7-1 and Table 7-1 for test circuit and loading. See Figure 7-2, Figure 7-3, and Figure 7-4 for measurement waveforms.

										В	-Port S	upply	Voltag	e (V <sub>CC</sub>	в)							
	PARAMETER	FROM	то	Test Conditions	1.2 ±	t 0.1 V	1.	5 ± 0.1	٧	1.8	3 ± 0.15	V	2.	5 ± 0.2	٧	3.	3 ± 0.3	٧	5.	0 ± 0.5	٧	UNIT
					MIN T	YP MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
		Α	В	-40°C to 85°C	0.5	69	0.5		24	0.5		18	0.5		13	0.5		10	0.5		8	
	Propagation	^	В	-40°C to 125°C	0.5	69	0.5		24	0.5		19	0.5		13	0.5		11	0.5		8	
t <sub>pd</sub>	delay	В	Α	-40°C to 85°C	0.5	31	0.5		15	0.5		12	0.5		9	0.5		8	0.5		8	ns
		В		-40°C to 125°C	0.5	31	0.5		16	0.5		13	0.5		10	0.5		9	0.5		8	
		OE	А	-40°C to 85°C	10.8	60	7.7		42	5.9		38	4.2		31	3.4		31	2.8		30	
	Disable time	OE	^	-40°C to 125°C	10.8	62	7.7		46	5.9		40	4.2		33	3.4		33	2.8		32	
t <sub>dis</sub>	Disable time	OE	В	-40°C to 85°C	9.7	109	5.9		69	13.2		56	8.4		40	6.9		37	3.7		30	ns
		OL		-40°C to 125°C	9.7	111	5.9		73	13.2		60	8.4		43	6.9		39	3.7		33	
		OE	Α	-40°C to 85°C	6.0	102	2.8		44	1.2		33	0.5		25	0.5		22	0.5		21	
	Enable time	OE	^	-40°C to 125°C	6.0	102	2.8		46	1.2		36	0.5		27	0.5		24	0.5		23	
t <sub>en</sub>	Enable time	OE	В	-40°C to 85°C	16.7	212	8.8		82	4.8		58	1.6		35	0.5		26	0.5		19	ns
		OL		-40°C to 125°C	16.7	212	8.8		83	4.8		60	1.6		37	0.5		28	0.5		21	

Product Folder Links: TXU202-Q1



## **6.12 Operating Characteristics**

 $T_A = 25^{\circ}C^{(1)}$ 

				Sı	ipply Voltage	(V <sub>CCB</sub> = V <sub>CC</sub>	;A)		
	PARAMETER	Test Conditions	1.2 ± 0.1 V	1.5 ± 0.1 V	1.8 ± 0.15 V	2.5 ± 0.2 V	3.3 ± 0.3 V	5.0 ± 0.5 V	UNIT
			TYP	TYP	TYP	TYP	TYP	TYP	
	A to B: outputs enabled	A Port	2	2	2	2	2	3	
C <sub>pdA</sub> (2)	A to B: outputs disabled	CL = 0, RL = Open	2	2	2	2	2	3	pF
OpdA	B to A: outputs enabled	f = 10 MHz	12	12	12	13	13	16	ρι
	B to A: outputs disabled	t <sub>rise</sub> = t <sub>fall</sub> = 1 ns	2	2	2	2	2	3	
	A to B: outputs enabled	B Port	12	12	12	13	13	16	
C <sub>pdB</sub> (3)	A to B: outputs disabled	CL = 0, RL = Open	2	2	2	2	2	3	pF
pdB (	B to A: outputs enabled	f = 10 MHz	2	2	2	2	2	3	ρΙ
	B to A: outputs disabled	t <sub>rise</sub> = t <sub>fall</sub> = 1 ns	2	2	2	2	2	3	

<sup>(1)</sup> See the CMOS Power Consumption and Cpd Calculation application report for additional information about how power dissipation capacitance affects power consumption.

A-Port power dissipation capacitance per transceiver.

<sup>(3)</sup> B-Port power dissipation capacitance per transceiver.



#### 6.13 Typical Characteristics

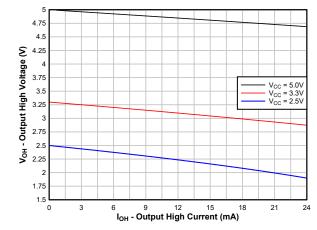


Figure 6-1. Typical ( $T_A$ =25°C) Output High Voltage ( $V_{OH}$ ) vs Source Current ( $I_{OH}$ )

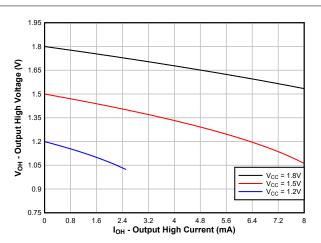


Figure 6-2. Typical ( $T_A$ =25°C) Output High Voltage ( $V_{OH}$ ) vs Source Current ( $I_{OH}$ )

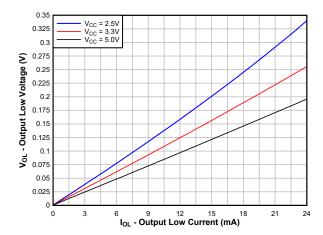


Figure 6-3. Typical ( $T_A$ =25°C) Output Low Voltage ( $V_{OL}$ ) vs Sink Current ( $I_{OL}$ )

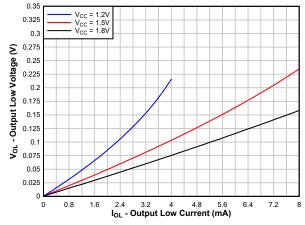


Figure 6-4. Typical ( $T_A$ =25°C) Output Low Voltage ( $V_{OL}$ ) vs Sink Current ( $I_{OL}$ )

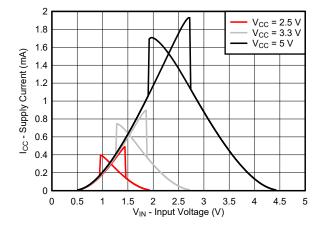


Figure 6-5. Typical ( $T_A$ =25°C) Supply Current ( $I_{CC}$ ) vs Input Voltage ( $V_{IN}$ )

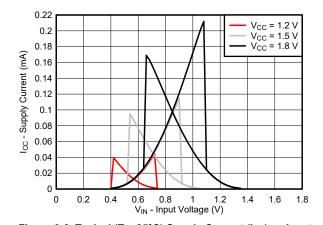


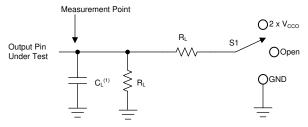
Figure 6-6. Typical ( $T_A$ =25°C) Supply Current ( $I_{CC}$ ) vs Input Voltage ( $V_{IN}$ )

### 7 Parameter Measurement Information

## 7.1 Load Circuit and Voltage Waveforms

Unless otherwise noted, generators supply all input pulses that have the following characteristics:

- f = 1 MHz
- Z<sub>O</sub> = 50 Ω
- Δt/ΔV ≤ 1 ns/V

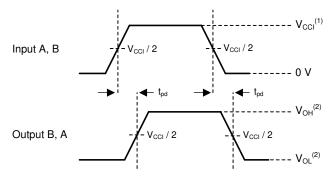


C<sub>L</sub> includes probe and jig capacitance.

Figure 7-1. Load Circuit

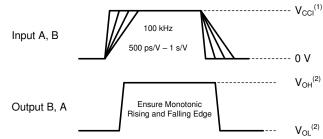
**Table 7-1. Load Circuit Conditions** 

	Parameter	V <sub>cco</sub>	R <sub>L</sub>	CL	S <sub>1</sub>	V <sub>TP</sub>
t <sub>pd</sub>	Propagation (delay) time	1.1 V – 5.5 V	10 kΩ	5 pF	Open	N/A
		1.1 V – 1.6 V	10 kΩ	5 pF	2 × V <sub>CCO</sub>	0.1 V
t <sub>en</sub> , t <sub>dis</sub>	Enable time, disable time	1.65 V – 2.7 V	10 kΩ	5 pF	2 × V <sub>CCO</sub>	0.15 V
		3.0 V – 5.5 V	10 kΩ	5 pF	2 × V <sub>CCO</sub>	0.3 V
		1.1 V – 1.6 V	10 kΩ	5 pF	GND	0.1 V
t <sub>en</sub> , t <sub>dis</sub>	Enable time, disable time	1.65 V – 2.7 V	10 kΩ	5 pF	GND	0.15 V
		3.0 V – 5.5 V	10 kΩ	5 pF	GND	0.3 V



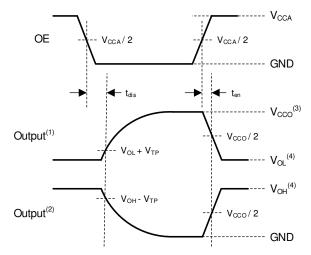
- 1.  $V_{\text{CCI}}$  is the supply pin associated with the input port.
- 2.  $V_{OH}$  and  $V_{OL}$  are typical output voltage levels that occur with specified  $R_L$ ,  $C_L$ , and  $S_1$

Figure 7-2. Propagation Delay



- 1. V<sub>CCI</sub> is the supply pin associated with the input port.
- 2.  $V_{OH}$  and  $V_{OL}$  are typical output voltage levels that occur with specified  $R_L,\,C_L,$  and  $S_1$

Figure 7-3. Input Transition Rise and Fall Rate



- 1. Output waveform on the condition that input is driven to a valid Logic Low.
- 2. Output waveform on the condition that input is driven to a valid Logic High.
- 3. V<sub>CCO</sub> is the supply pin associated with the output port.
- 4.  $V_{OH}$  and  $V_{OL}$  are typical output voltage levels with specified  $R_L$ ,  $C_L$ , and  $S_1$ .

Figure 7-4. Enable Time And Disable Time

## 8 Detailed Description

#### 8.1 Overview

The TXU0202-Q1 is a 4-bit translating transceiver that uses two individually configurable power-supply rails. The device is operational with  $V_{CCA}$  and  $V_{CCB}$  supplies as low as 1.1 V and as high as 5.5 V. Additionally, the device can be operated with  $V_{CCA} = V_{CCB}$ . The A port is designed to track  $V_{CCA}$ , and the B port is designed to track  $V_{CCB}$ .

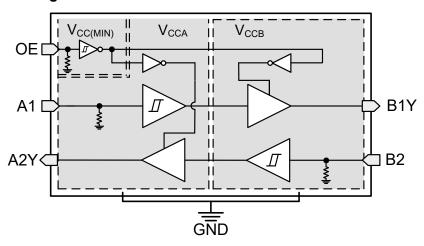
The TXU0202-Q1 device is designed for asynchronous communication between data buses, and transmits data with fixed direction from the A bus to the B bus on some channels and from the B bus to the A bus on the remaining channels. The output-enable input (OE) is used to disable the outputs so the buses are effectively isolated. The output-enable pin of the TXU0202-Q1 (OE) can be referenced to either  $V_{CCA}$  or  $V_{CCB}$ . The OE pin can be left floating or externally pulled down to ground to ensure the high-impedance state of the level shifter outputs during power up or power down.

This device is fully specified for partial-power-down applications using the I<sub>off</sub> current. The I<sub>off</sub> protection circuitry ensures that no excessive current is drawn from or sourced into an input or output while the device is powered down.

The VCC isolation or VCC disconnect feature ensures that if either VCC is less than 100 mV or disconnected with the complementary supply within recommended operating conditions, then the outputs disable and are set to the high-impedance state while the supply current is maintained. The I<sub>off-float</sub> circuitry ensures that no excessive current is drawn from or sourced into an input or output while the supply is floating.

Glitch-free power supply sequencing allows either supply rail to be powered on or off in any order while providing robust power sequencing performance.

#### 8.2 Functional Block Diagram



#### 8.3 Feature Description

#### 8.3.1 CMOS Schmitt-Trigger Inputs with Integrated Pulldowns

Standard CMOS inputs are high impedance and are typically modeled as a resistor in parallel with the input capacitance given in the *Electrical Characteristics*. The worst case resistance is calculated with the maximum input voltage, given in the *Absolute Maximum Ratings*, and the maximum input leakage current, given in the *Electrical Characteristics*, using ohm's law  $(R = V \div I)$ .

The Schmitt-trigger input architecture provides hysteresis as defined by  $\Delta V_T$  in the *Electrical Characteristics*, which makes this device extremely tolerant to slow or noisy inputs. Driving the inputs slowly will increase dynamic current consumption of the device. See *Understanding Schmitt Triggers* for additional information regarding Schmitt-trigger inputs.

#### 8.3.1.1 Inputs with Integrated Static Pull-Down Resistors

This device has 5 M $\Omega$  typical integrated weak pull-downs for each input. This feature allows all inputs to be left floating without the concern for unstable outputs or increased current consumption. This also helps to reduce external component count for applications where not all channels are used or need to be fixed low. If an external pull-up is required, it should be no larger than 1 M $\Omega$  to avoid contention with the 5 M $\Omega$  internal pull-down.

## 8.3.2 Control Logic (OE) with V<sub>CC(MIN)</sub> Circuitry

The output-enable input (OE) is used to disable the outputs so the buses are effectively isolated. The output-enable pin of the TXU0x04 has  $V_{CC(MIN)}$  circuitry, which allows the OE pin to operate with the lower supply voltage. The *Over-Voltage Tolerant Inputs* feature allows the OE pin to operate with the higher supply voltage. This combination means that the enable pin can be referenced to either  $V_{CCA}$  or  $V_{CCB}$  supply. Multiple permutations of each device are possible since the controller can be placed on either the A or B port and can still control the enable pin.

#### 8.3.3 Balanced High-Drive CMOS Push-Pull Outputs

A balanced output allows the device to sink and source similar currents. The high drive capability of this device creates fast edges into light loads, so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. The electrical and thermal limits that must be followed at all times are defined in *Absolute Maximum Ratings*.

#### 8.3.4 VCC Isolation and V<sub>CC</sub> Disconnect

The outputs for this device disable and enter a high-impedance state when either supply is <100 mV or left floating (disconnected), with the complementary supply within the recommended operating conditions. It is recommended to keep the inputs low before floating (disconnecting) either supply.

The I<sub>CCx(floating)</sub> in the *Electrical Characteristics* specifies the maximum supply current. The I<sub>off(float)</sub> in the *Electrical Characteristics* specifies the maximum leakage into or out of any input or output pin on the device.

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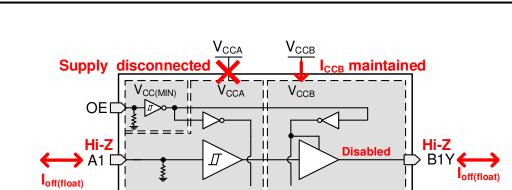


Figure 8-1. V<sub>CC</sub> Disconnect Feature

**GND** 

#### 8.3.5 Over-Voltage Tolerant Inputs

Input signals to this device can be driven above the supply voltage as long as they remain below the maximum input voltage value specified in the *Recommended Operating Conditions*.

#### 8.3.6 Glitch-Free Power Supply Sequencing

Either supply rail may be powered on or off in any order without producing a glitch on the inputs or outputs (that is, where the output erroneously transitions to VCC when it should be held low or vice versa). Glitches of this nature can be misinterpreted by a peripheral as a valid data bit, which could trigger a false device reset of the peripheral, a false device configuration of the peripheral, or even a false data initialization by the peripheral.



### 8.3.7 Negative Clamping Diodes

Figure 8-2 shows the inputs and outputs to this device that have negative clamping diodes.

#### **CAUTION**

Voltages beyond the values specified in the *Absoulte Maximum Ratings* table can cause damage to the device. The input negative-voltage and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

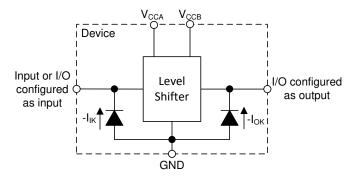


Figure 8-2. Electrical Placement of Clamping Diodes for Each Input and Output

#### 8.3.8 Fully Configurable Dual-Rail Design

The  $V_{CCA}$  and  $V_{CCB}$  pins can be supplied at any voltage from 1.1 V to 5.5 V, making the device suitable for translating between any of the voltage nodes (1.2 V, 1.5 V, 1.8 V, 3.3 V, and 5.0 V).

#### 8.3.9 Supports High-Speed Translation

The TXU0202-Q1 device can support high data-rate applications. The translated signal data rate can be up to 200 Mbps when the signal is translated from 3.3 V to 5.0 V.

#### 8.4 Device Functional Modes

**Table 8-1. Function Table** 

CONTROL INPUTS	Port S	tatus	OPERATION
OE	Input	Output	OPERATION
Н	L	L	Unidirectional non-inverting voltage translation
Н	Н	Н	Unidirectional non-inverting voltage translation
L	Х	Hi-Z	Isolation

Product Folder Links: TXU202-Q1

## 9 Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

The TXU0202-Q1 device can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. The TXU0202-Q1 device is ideal for use in applications where a push-pull driver is connected to the data Inputs. The maximum data rate can be up to 200 Mbps when the device translates a signal from 3.3 V to 5.0 V.

#### 9.2 Typical Application

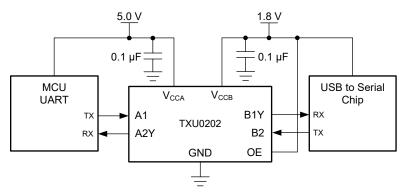


Figure 9-1. TXU0202-Q1 LED Driver Application

#### 9.2.1 Design Requirements

Use the parameters listed in Table 9-1 for this design example.

**Table 9-1. Design Parameters** 

DESIGN PARAMETERS	EXAMPLE VALUES
Input voltage range	1.1 V to 5.5 V
Output voltage range	1.1 V to 5.5 V

### 9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
  - Use the supply voltage of the device that is driving the TXU0202-Q1 device to determine the input voltage range. For a valid logic-high, the value must exceed the positive-going input-threshold voltage (V<sub>T+</sub>) of the input port. For a valid logic low the value must be less than the negative-going input-threshold voltage (V<sub>T-</sub>) of the input port.
- Output voltage range
  - Use the supply voltage of the device that the TXU0202-Q1 device is driving to determine the output voltage range.



#### 9.2.3 Application Curve

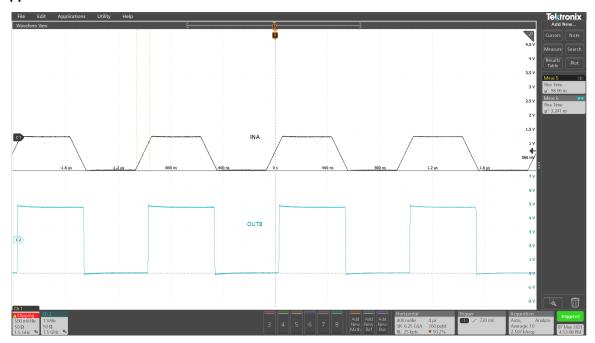


Figure 9-2. Up Translation at 1 MHz (1.2 V to 5 V)

## 10 Power Supply Recommendations

Always apply a ground reference to the GND pins first. This device is designed for glitch free power sequencing without any supply sequencing requirements such as ramp order or ramp rate.

Glitch-Free Power Supply Sequencing describes how this device was designed with various power supply sequencing methods in mind to help prevent unintended triggering of downstream devices.

11 Layout

## 11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit board layout guidelines is recommended:

- Use bypass capacitors on the power supply pins and place them as close to the device as possible. A 0.1 μF capacitor is recommended, but transient performance can be improved by having 1 μF and 0.1 μF capacitors in parallel as bypass capacitors.
- The high drive capability of this device creates fast edges into light loads so routing and load conditions should be considered to prevent ringing.

### 11.2 Layout Example

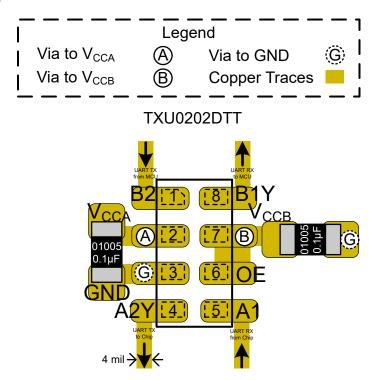


Figure 11-1. Layout Example - TXU0202-Q1



## 12 Device and Documentation Support

## 12.1 Device Support

#### 12.1.1 Regulatory Requirements

No statutory or regulatory requirements apply to this device.

There are no special characteristics for this product.

### **12.2 Documentation Support**

#### 12.2.1 Related Documentation

- Texas Instruments, Understanding Schmitt Triggers application report
- Texas Instruments, CMOS Power Consumption and Cod Calculation application report

## 12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 12.4 Support Resources

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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#### 12.5 Trademarks

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#### 12.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 12.7 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

#### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

www.ti.com 10-Feb-2023

#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TXU0202QDCURQ1	ACTIVE	VSSOP	DCU	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125		Samples
TXU0202QDTTRQ1	ACTIVE	X1SON	DTT	8	5000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	1LU	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## **PACKAGE OPTION ADDENDUM**

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#### OTHER QUALIFIED VERSIONS OF TXU0202-Q1:

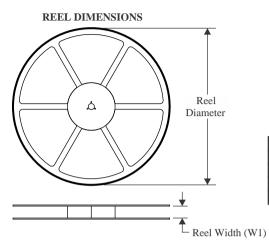
NOTE: Qualified Version Definitions:

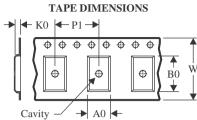
Catalog - TI's standard catalog product

## **PACKAGE MATERIALS INFORMATION**

www.ti.com 17-Apr-2023

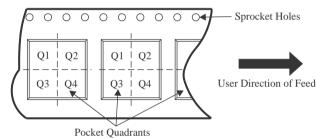
### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

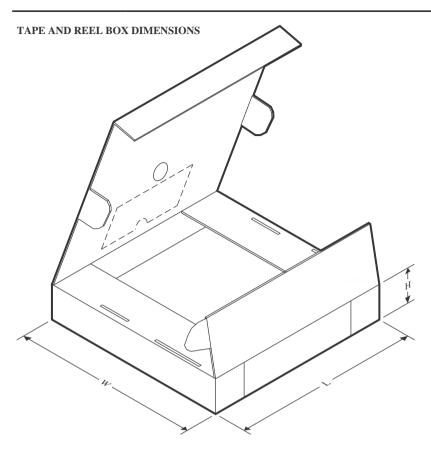
#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TXU0202QDCURQ1	VSSOP	DCU	8	3000	178.0	9.0	2.25	3.35	1.05	4.0	8.0	Q3
TXU0202QDTTRQ1	X1SON	DTT	8	5000	178.0	8.4	1.17	2.17	0.63	4.0	8.0	Q1

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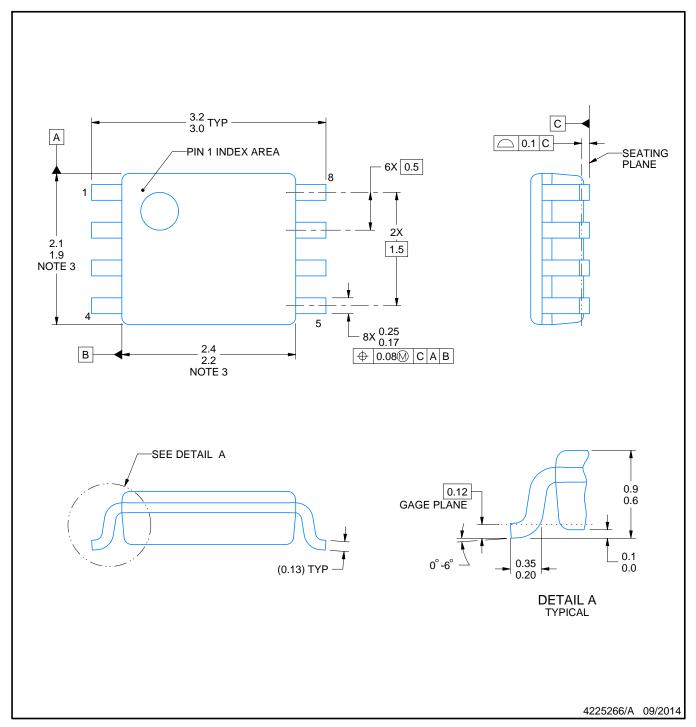


### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TXU0202QDCURQ1	VSSOP	DCU	8	3000	180.0	180.0	18.0
TXU0202QDTTRQ1	X1SON	DTT	8	5000	205.0	200.0	33.0



SMALL OUTLINE PACKAGE



#### NOTES:

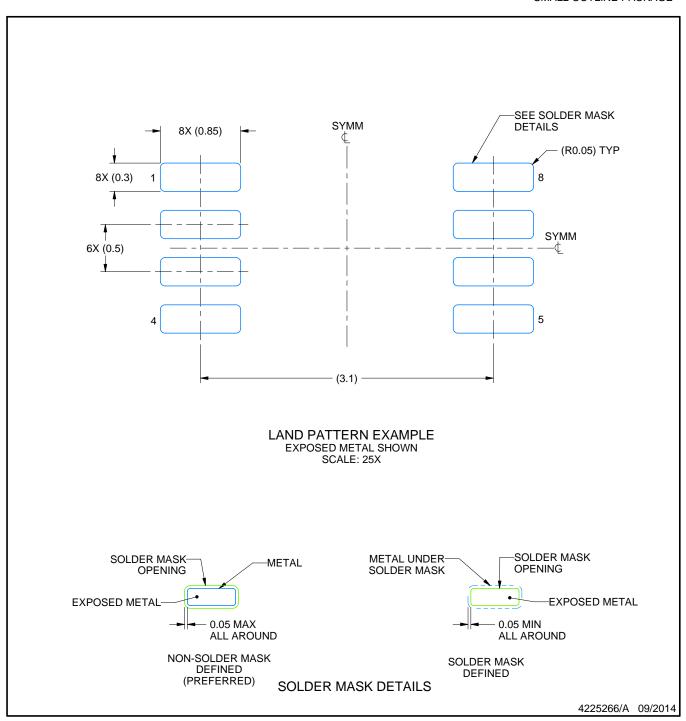
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-187 variation CA.



SMALL OUTLINE PACKAGE

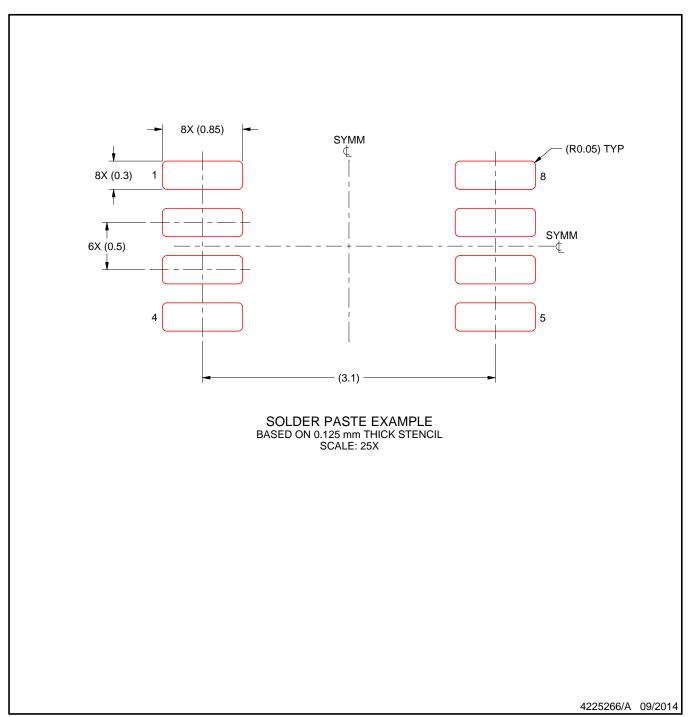


NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



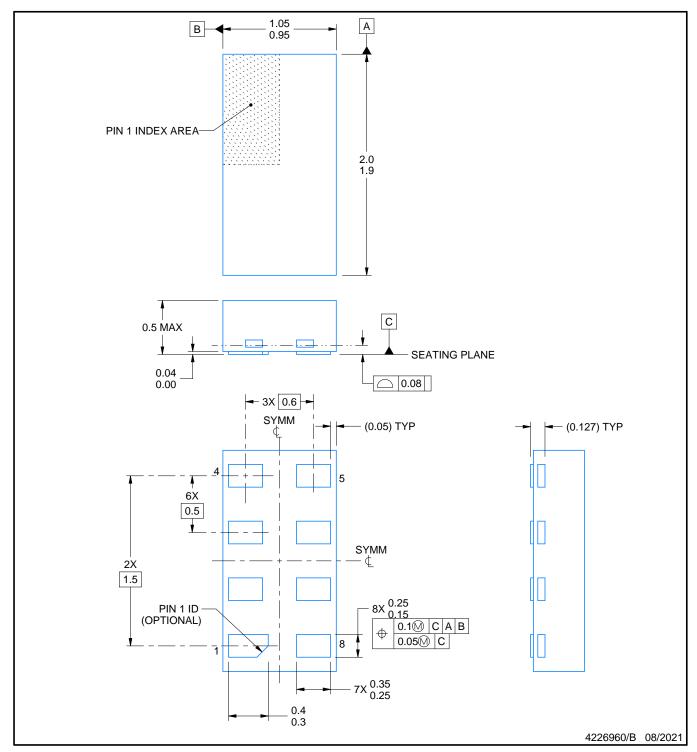
NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.





PLASTIC SMALL OUTLINE - NO LEAD



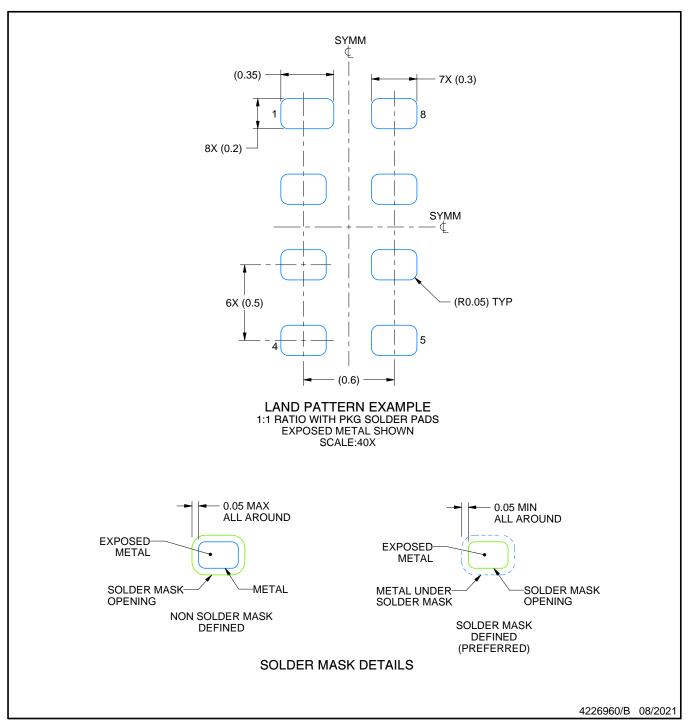
#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.



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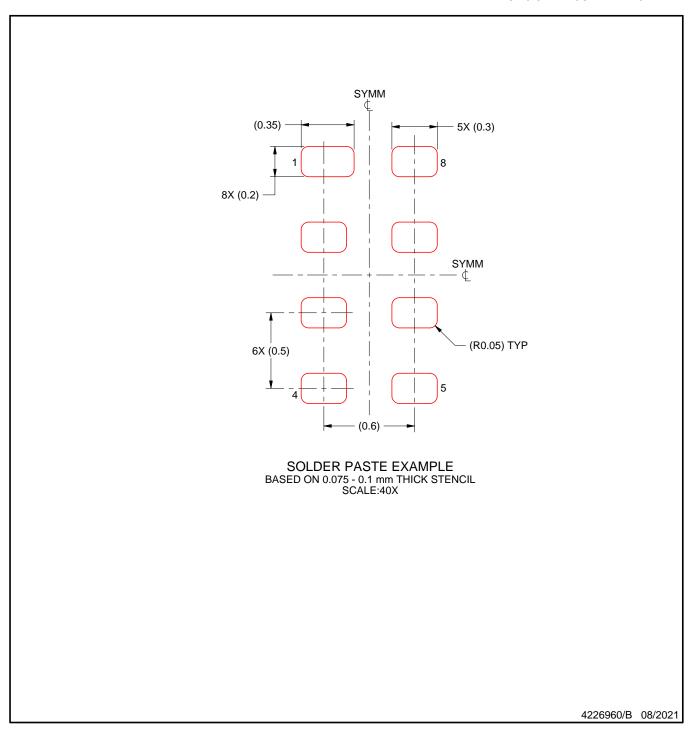


NOTES: (continued)

3. For more information, see QFN/SON PCB application report in literature No. SLUA271 (www.ti.com/lit/slua271).



PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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NLA9306MU3TCG PI4ULS3V304AZMAEX PI4ULS3V504AZMAEX 74AVCH1T45FW3-7 NLSX5011AMUTAG 74AXP1T34GWH
ST2149BQTR MC100ELT21DR2G MC100LVELT22MNRG MC10ELT20DR2G MC10EPT20MNR4G MC14504BFELG
NLSV4T3234FCT1G NLSX3378BFCT1G UM3208QA UM3208H UM3304 UM3304QT UM3202H UM3308 RS0104YTQE12
RS0204YUTQH12 AW39204QNR AW39114FOR RS0104YTQF14 RS0204YTQF14 UM3204QT UM3204QB UM3204QV
AIPTB0106TA16.TR AIPTS0104TA14.TR AIPTB0104TA14.TR UM3304QS SN74LXC2T45DCUR TXU0202DCUR TCA39306DTMR
NTS0102TL-Q100H AW39112DNR